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RGB Color, Infrared, and Temperature Sensors

General Description

The MAX44006/MAX44008 integrate six sensors in two products: red, green, blue (RGB) sensors; an ambient light (clear) sensor; a temperature sensor; and an ambient infrared sensor with an I²C interface. These highly integrated optical sensors include a temperature sensor to improve reliability and performance.

The devices compute the light information with six parallel data converters allowing simultaneous light measurement in a very short time. The devices consume only 15 μ A (MAX44006) and 16 μ A (MAX44008) separately in RGBC + TEMP + IR mode, and also have the ability to operate at 1.7V to 2.0V (MAX44006) and 2.7V to 5.5V supply voltage (MAX44008).

The devices' RGB sensing capability improves the performance of end products by providing robust and precise information for ambient color-sensing and color-temperature measurement.

The devices' superior infrared and 50Hz/60Hz rejection provide robust readings. The wide dynamic range light measurement makes these products perfect candidates for many color measurement applications.

The on-chip ambient sensor has the ability to make wide dynamic range $(0.002 \sim 8388.61 \mu W/cm^2)$ lux measurements. The devices' digital computation power provides programmability and flexibility for end-product design. A programmable interrupt pin minimizes the need to poll the devices for data, freeing up microcontroller resources, reducing system software overhead, and ultimately reducing power consumption. All these features are included in a tiny 2mm x 2mm x 0.6mm optical package.

Applications

- TVs/Display Systems Tablet PCs/Notebooks/e-Readers Printers LED and Laser Projectors Digital Light Management Industrial Sensors Tablets
- Color Correction

Ordering Information appears at end of data sheet.

For related parts and recommended products to use with this part, refer to www.maximintegrated.com/MAX44006.related.

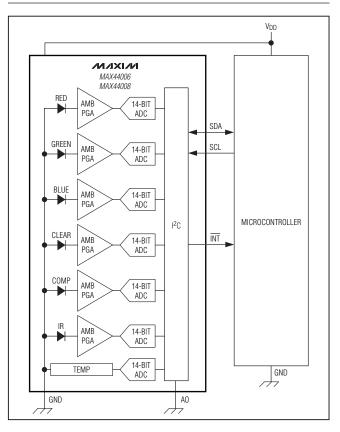
For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

Features

- Optical Sensor Fusion for True Color Sensing
 Seven Parallel ADCs
 - ♦ R, G, B, IR, ALS Sensing
- ♦ Superior Sensitivity
 ♦ 0.001 Lux
- Optimized for Overall System Power Consumption
 - ♦ 10µA (MAX44006)/10µA (MAX44008) in Ambient Mode

 - \diamond 0.01µA (MAX44006)/0.5µA (MAX44008) in Shutdown Mode
- Digital Functionalities
 - Programmable Channel Gains
 - ♦ Adjustable Interrupt Thresholds
- ♦ High-Level Integration
 ♦ Six Sensors in a 2mm x 2mm x 0.6mm Package

Functional Diagram



RGB Color, Infrared, and Temperature Sensors

ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND (MAX44006)	0.3V to +2.2V
V _{DD} to GND (MAX44008)	0.3V to +6.0V
A0, INT, SCL, SDA to GND	0.3V to +6.0V
Output Short-Circuit Current Duration	Continuous
Continuous Input Current into Any Terminal.	±20mA

Continuous Power Dissipation	
(derate 11.9mW/°C above +70°C)953	mW
Operating Temperature Range40°C to +8	5°C
Soldering Temperature (reflow)+26	0°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 1)

OTDFN (Note 1)

Junction-to-Ambient Thermal Resistance (θ_{JA})....+83.9°C/W Junction-to-Case Thermal Resistance (θ_{JC})............+37°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = 1.8V (MAX44006), V_{DD} = 3.3V (MAX44008), T_A = +25^{\circ}C, min/max are from -40^{\circ}C to +85^{\circ}C, unless otherwise noted.) (Note 2)$

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS		
COLOR-SENSOR CHARACTER	ISTICS							
		Clear = 538nm		0.002				
		Red = 630nm		0.002				
Maximum Sensitivity (Note 3)		Green = 538nm		0.002		µW/cm ²		
		Blue = 470nm		0.004				
		Infrared = 850nm		0.002				
		Clear = 538nm		8388				
		Red = 630nm		8388				
Maximum Sense Capability		Green = 538nm		8388		µW/cm ²		
		Blue = 470nm		16,777				
		Infrared = 850nm		8388				
Total Error	TE	Power = 10μ W/cm ² , red = 630nm, green = 538nm, blue = 470nm, T _A = +25°C, clear = 538nm, IR = 850nm		2	15	%		
Gain Matching		Red to green to blue, $T_A = +25^{\circ}C$		0.5	10	%		
Power-Up Time	t _{ON}			10		ms		
Dark-Level Counts		6.25ms conversion time, 0 lux, $T_A = +25^{\circ}C$			2	Counts		
		14-bit resolution (Note 4)		400				
		14-bit resolution, $T_A = +25^{\circ}C$	100					
ADC Conversion Time		12-bit resolution		25		ms		
		10-bit resolution		6.25				
		8-bit resolution		1.5625]		

RGB Color, Infrared, and Temperature Sensors

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = 1.8V (MAX44006), V_{DD} = 3.3V (MAX44008), T_A = +25^{\circ}C, min/max are from -40^{\circ}C to +85^{\circ}C, unless otherwise noted.) (Note 2)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
		$T_A = +25^{\circ}C$		1	10		
ADC Conversion Accuracy		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 5)}$		2	15	%	
TEMPERATURE SENSOR							
		$T_A = +25^{\circ}C \sim +55^{\circ}C$		±1	±3		
Accuracy (Note 5)		$T_{A} = 0^{\circ}C \sim +70^{\circ}C$		±2	±5	°C	
Resolution				0.25		°C/LSB	
POWER SUPPLY							
Rower Supply Voltage	\/	MAX44006, guaranteed by total error	1.7		2	V	
Power-Supply Voltage	V _{DD}	MAX44008, guaranteed by total error	2.7		5.5	v	
		MAX44006, CLEAR mode		10	18		
Quiescent Current	I _{DD}	MAX44006, RGBC + IR mode		15	30	μA	
	עטי	MAX44008, CLEAR mode		10	18	μπ	
		MAX44008, RGBC + IR mode		16	30		
Software Shutdown Current	ISHDN	MAX44006, T _A = +25°C		-	1	μA	
		MAX44008, T _A = +25°C			1.5		
DIGITAL CHARACTERISTICS							
Output Low Voltage SDA	V _{OL}	I _{SINK} = 6mA			0.4	V	
I ² C Input Voltage High	VIH	SDA, SCL, A0	1.4			V	
I ² C Input Voltage Low	VIL	SDA, SCL, A0			0.4	V	
Input Hysteresis	V _{HYS}			200		mV	
Input Capacitance	C _{IN}			10		pF	
Input Leakage Current	1	$V_{IN} = 0V, T_A = +25^{\circ}C$			0.1	μA	
Input Leakage Current	IIN	$V_{IN} = 5.5V, T_A = +25^{\circ}C$			0.1	μΑ	
I ² C TIMING CHARACTERISTICS	(Note 6)		· · · · · · · · · · · · · · · · · · ·				
Serial Clock Frequency	fSCL		0		400	kHz	
Bus Free Time Between STOP and START	t _{BUF}		1.3			μs	
Hold Time (Repeated) START Condition	t _{HD,STA}		0.6			μs	
Low Period of the SCL Clock	tLOW		1.3			μs	
High Period of the SCL Clock	tHIGH		0.6			μs	
Setup Time for a Repeated START	tsu.sta		0.6			μs	
Setup Time for STOP Condition	t _{SU,STO}		0.6			μs	
Data Hold Time	thd,dat		0		0.9	μs	
Data Setup Time	t _{SU,DAT}		100		-	ns	
Bus Capacitance	C _B				400	pF	

RGB Color, Infrared, and Temperature Sensors

ELECTRICAL CHARACTERISTICS (continued)

(V_{DD} = 1.8V (MAX44006), V_{DD} = 3.3V (MAX44008), T_A = +25°C, min/max are from -40°C to +85°C, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
SDA and SCL Receiving Rise Time	t _R		20 + 0.1C _B		300	ns
SDA and SCL Receiving Fall Time	t⊨		20 + 0.1C _B		300	ns
SDA Transmitting Fall Time	t _f		20 + 0.1C _B		250	ns
Pulse Width of Suppressed Spike	t _{SP}		0		50	ns

Note 2: 100% production tested at $T_A = +25^{\circ}C$. Specifications over temperature limits are guaranteed by bench or ATE characterization. **Note 3:** In AMBTIM[2:0] mode (100ms integration time).

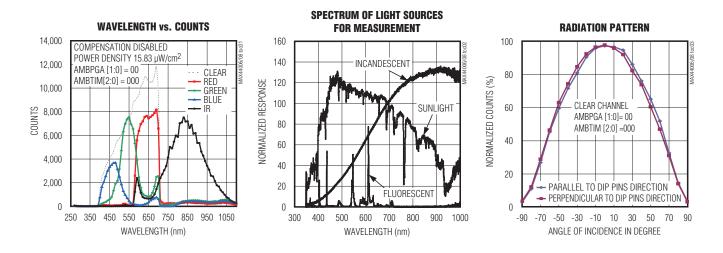
Note 4: At 14-bit resolution mode. Sensitivity is 4 times higher with 400ms integration time than 100ms integration time.

Note 5: Production tested only at +25°C, guaranteed by bench characterization across temperature.

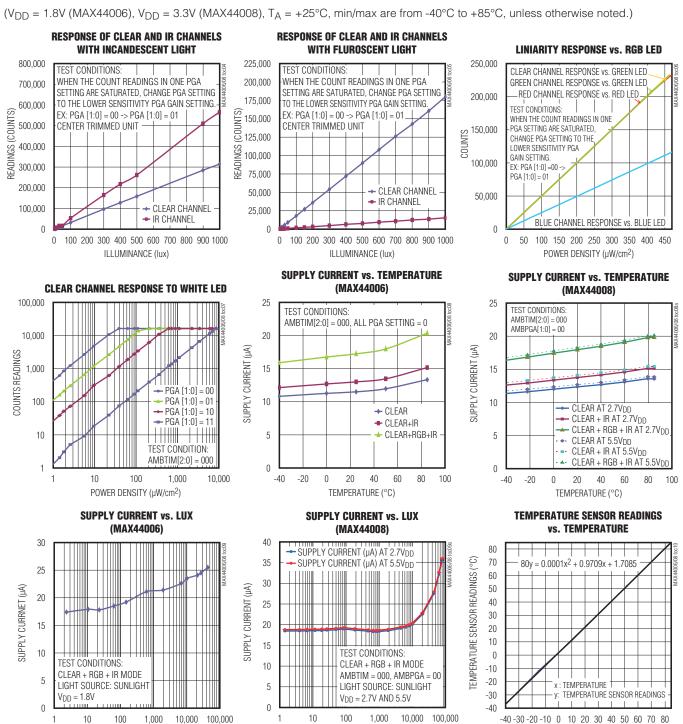
Note 6: Design guidance only, not production tested.

Typical Operating Characteristics

 $(V_{DD} = 1.8V (MAX44006), V_{DD} = 3.3V (MAX44008), T_A = +25^{\circ}C, min/max are from -40^{\circ}C to +85^{\circ}C, unless otherwise noted.)$



RGB Color, Infrared, and Temperature Sensors



1

REFERENCE METER READING (lux)

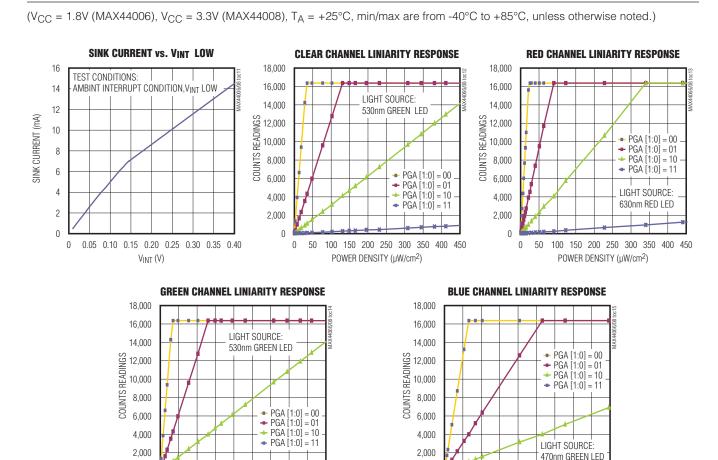
Typical Operating Characteristics (continued)

Maxim Integrated

REFERENCE METER READING (lux)

TEMPERATURE (°C)

RGB Color, Infrared, and Temperature Sensors



0

0 50

100 150 200 250 300 350 400 450

POWER DENSITY (µW/cm²)

Typical Operating Characteristics (continued)

Maxim Integrated

0

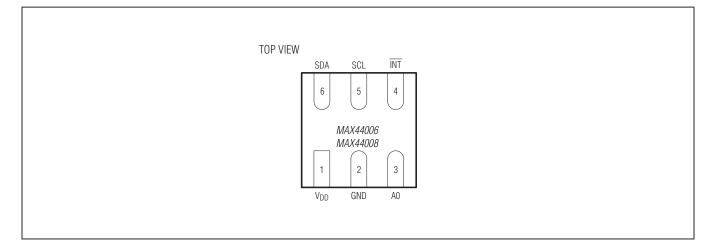
0 50

100 150 200 250 300 350 400 450

POWER DENSITY (µW/cm²)

RGB Color, Infrared, and Temperature Sensors

Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1	V _{DD}	Power Supply
2	GND	Ground
3	AO	Address Select. Pull high to select address 1000 100x (MAX44006), 1000 000x (MAX44008) or low to select address 1000 101x (MAX44006), 1000 001x (MAX44008).
4	ĪNT	Interrupt
5	SCL	I ² C Clock
6	SDA	I ² C Data

Detailed Description

The MAX44006/MAX44008 combine a wide-dynamic range color sensor capable of measuring red, green, and blue (RGB) and infrared content of ambient light. The devices also have a digital I²C interface, advanced TEMP sensor, and interrupt pin functionality to make interfacing with it easy. The die is placed inside an optically transparent (OTDFN) package.

A photodiode array inside the devices converts the light to a current, which is then processed by low-power circuitry and a sigma-delta ADC into a digital bit stream. The data is then stored in an output register that can be read by an I^2C master.

The user can choose whether to read just the clear channel, or clear + IR channel, or clear + RGB + IR channels. Due to parallel conversion by on-chip ADCs, there is no additional delay in making ambient light conversions for multiple channels.

Key features of the devices include high-level integration, low-power design, small packaging, and interrupt pin operation. An on-chip programmable interrupt function eliminates the need to continually poll the devices for data, resulting in a significant power saving.

RGB Color, Infrared, and Temperature Sensors

Ambient Light Sensing

Ambient light sensors are designed to detect brightness the same way human eyes do. To achieve this, the light sensor needs to have a spectral sensitivity that is identical to the photopic curve of the human eye. See Figure 1.

The devices' color sensors are designed to accurately derive the color chromaticity and intensity of ambient light. With parallel ADC conversion circuits, conversion data from multiple channels can be read at the same time. An interrupt signal can also be dynamically configured with higher and lower thresholds, and a persist timer. The interrupt is latched until the master reads the Interrupt Status register. This allows the master to stay in power-efficient sleep mode until a change in lighting condition alerts it.

Variation between light sources can extend beyond the visible spectral range—fluorescent, incandescent, and sunlight, for example, have substantially different IR radiation content. The devices incorporate on-chip measurement of RGBC and IR of compensation of ambient light, allowing accurate lux detection in a variety of lighting conditions, as well as identification of type of light source.

On-chip user-programmable clear, RGB, infrared channel gain registers allow the light sensor response to also

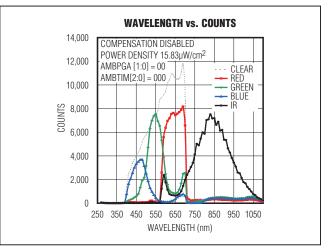


Figure 1. Wavelength vs. Counts

be tailored for specific applications, such as when the light sensor is placed under a colored or black glass.

Temperature Sensor

The devices also integrate a temperature sensor that can be used for ambient temperature measurement and compensation. A nonlinear response is designed to replicate the effect of temperature on the photodiodes used on the chip.

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BITO	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
STATUS											
Interrupt Status				RESET	SHDN	PWRON		AMBINTS	0x00	0X04	R/W
CONFIGURAT	ΓΙΟΝ										
Main Configuration			MODE	E[1:0]	AMBS	EL[1:0]		AMBINTE	0x01	0x00	R/W
Ambient Configuration	TRIM	COMPEN	TEMPEN	Δ	MBTIM[2:	0]	AMBF	PGA[1:0]	0x02	0x20	R/W

Register Description

RGB Color, Infrared, and Temperature Sensors

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
AMBIENT RE	ADING								1		
Ambient CLEAR High Byte					AMB_CL	EAR[13:8]			0x04	0x00	R
Ambient CLEAR Low Byte				AMB_CL	EAR[7:0]				0x05	0x00	R
Ambient RED High Byte					AMB_R	ED[13:8]			0x06	0x00	R
Ambient RED Low Byte				AMB_F	RED[7:0]				0x07	0x00	R
Ambient GREEN High Byte					AMB_GR	EEN[13:8]			0x08	0x00	R
Ambient GREEN Low Byte	AMB_GREEN[7:0]								0x09	0x00	R
Ambient BLUE High Byte					AMB_BL	_UE[13:8]			0x0A	0x00	R
Ambient BLUE Low Byte				AMB_B	LUE[7:0]				0x0B	0x00	R
Ambient INFRARED High Byte					AMB_	IR[13:8]			0x0C	0x00	R
Ambient INFRARED Low Byte				AMB_	0x0D	0x00	R				
Ambient IR COMP High Byte			AMB_IRCOMP[13:8]							0x00	R
Ambient IR COMP Low Byte				AMB_IRC	0x0F	0x00	R				
TEMP High Byte					TEMF	P[13:8]			0x12	0x00	R

Register Description (continued)

RGB Color, Infrared, and Temperature Sensors

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
TEMP Low Byte				TEMF	P[7:0]				0x13	0x00	R
INTERRUPT 1	THRESHC	DLDS							• •		
AMB Upper Threshold— High Byte					UPTH	R[13:8]			0x14	0xFF	R/W
AMB Upper Threshold— Low Byte				UPTH	R[7:0]				0x15	0xFF	R/W
AMB Lower Threshold— High Byte					LOTH	R[13:8]			0x16	0x00	R/W
AMB Lower Threshold— Low Byte			LOTHR[7:0]							0x00	R/W
Threshold Persist Timer							AMB	PST[1:0]	0x18	0x00	R/W
AMBIENT AD	C GAINS		-								
Digital Gain Trim of CLEAR Channel				TRIM_G	AIN_CLE	AR[6:0]			0x1D	0xXX	R/W
Digital Gain Trim of RED Channel				TRIM_	GAIN_RE	D[6:0]			0x1E	0xXX	R/W
Digital Gain Trim of GREEN Channel			TRIM_GAIN_GREEN[6:0]						0x1F	0xXX	R/W
Digital Gain Trim of BLUE Channel			TRIM_GAIN_BLUE[6:0]						0x20	0xXX	R/W
Digital Gain Trim of INFRARED Channel			TRIM_GAIN_IR[6:0]						0x21	0xXX	R/W

Register Description (continued)

RGB Color, Infrared, and Temperature Sensors

The individual register bits are explained below.

Interrupt Status (0x00)

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BITO	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
Interrupt Status				RESET	SHDN	PWRON		AMBINTS	0x00	0x04	R/W

The AMBINTS bit in the Interrupt Status register 0x00 is a read-only bit, and indicates that an ambient light-interrupt condition has occurred. If any of these bits (PWRON, AMBINTS) are set to 1, the INT pin is pulled low. The PWRON bit in the Interrupt Status register 0x00 is a read-only bit, and if set, indicates that a power-on-reset (POR) condition has occurred, and any user-programmed thresholds may not be valid anymore. The SHDN bit in the Interrupt Status register 0x00 is a read/write bit, and can be used to put the part into and bring out of shutdown for power saving. All register data is retained during this operation. The RESET bit in the Interrupt Status register 0x00 is also a read/write bit, and can be used to a power-on default condition.

Reading the Interrupt Status register clears the PWRON and AMBINTS bits if set, and deasserts the INT pin (INT pin is pulled high by the off-chip pullup resistor). The AMBINTS bits are disabled and set to 0 if the respective INTE Interrupt Enable bits in Register 0x01 are set to 0.

Table 1. Ambient INTERRUPT STATUS Flag (AMBINTS)

BIT0	OPERATION
0	No interrupt trigger event has occurred.
1	The ambient light has exceeded the designated window limits defined by the threshold registers for longer than persist timer count AMBPST[1:0]. It also causes the INT pin to be pulled low. Once set, the only way to clear this bit is to read this register. This bit is always set to 0 if AMBINTE bit is set to 0.

Table 2. Power-On INTERRUPT STATUS Flag (PWRON)

BIT2	OPERATION
0	Normal operating mode.
1	The part went through a power-up event, either because the part was turned on, or because there was a power-supply voltage glitch. All interrupt threshold settings in the registers have been reset to power-on default states, and should be examined if necessary. The INT pin is also pulled low. Once this bit is set, the only way to clear this bit is to read this register.

Table 3. Shutdown Control (SHDN)

BIT3	OPERATION
0	The part is in normal operation. When the part returns from shutdown, note that the value in data registers is not current until the first conversion cycle is completed.
1	The part can be put into a power-save mode by writing a 1 to this bit. Supply current is reduced to approximately 0.01 μ A (MAX44006) and 0.5 μ A (MAX44008) with no I ² C clock activity. While all registers remain accessible and retain data, ADC conversion data contained in them may not be current. Writeable registers also remain accessible in shutdown. All interrupts are cleared.

RGB Color, Infrared, and Temperature Sensors

Table 4. Reset Control (RESET)

BIT4	OPERATION
0	The part is in normal operation.
1	The part undergoes a forced POR sequence. All configuration, threshold, and data registers are reset to a power-on state by writing a 1 to this bit, and an internal hardware reset pulse is generated. This bit then automatically becomes 0 after the RESET sequence is completed. After resetting, the PWRON interrupt is triggered.

Main Configuration (0x01)

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
Main Configuration			MOD	E[1:0]	AMBSI	EL[1:0]		AMBINTE	0x01	0x20	R/W

Writing to the Main Configuration register does not abort any ambient data conversion (registers 0x04 to 0x0F) if already in progress. It applies the new settings during the next conversion period.

Table 5. Ambient Interrupt Enable (AMBINTE)

BIT0	OPERATION
0	The AMBINTS bit and INT pin remain unasserted even if an ambient interrupt event has occurred. The AMBINTS bit is set to 0 if previously set to 1. See Table 1 for more details.
1	Detection of ambient interrupt events is enabled (see the AMBINTS bit for more details). An ambient interrupt can trigger a hardware interrupt (INT pin pulled low) and set the AMBINTS bit (register 0x00, BIT0).

Note: Detection of an ambient interrupt event sets the AMBINTS bit (register 0x00, BIT0) only if AMBINTE bit is set to 1. If AMBINTS bits are set to 1, it pulls the interrupt INT pin low (asserts it). A read of the Interrupt Status register clears AMBINTS bits if set to 1, and deasserts the INT pin if pulled low.

The 2 AMBSEL[1:0] bits define four operating modes for the devices. Ensure that the respective ambient channels also enable use of the MODE[1:0] bits.

Table 6. Ambient Interrupt Select (AMBSEL[1:0])

AMBSEL[1:0]	OPERATION
00	CLEAR channel data is used to compare with ambient interrupt thresholds and ambient timer settings.
01	GREEN channel data is used to compare with ambient interrupt thresholds and ambient timer settings.
10	IR channel data is used to compare with ambient interrupt thresholds and ambient timer settings.
11	TEMP channel data is used to compare with ambient interrupt thresholds and ambient timer settings.

RGB Color, Infrared, and Temperature Sensors

The 2 MODE[1:0] bits define three operating modes for the devices, as shown in Table 7.

Table 7. MODE[1:0]

MODE[1:0]	OPERATING MODE	COMMENTS
00	Clear	CLEAR + TEMP* channels active
01	Clear + IR	CLEAR + TEMP* + IR channels active
10	Clear + RGB + IR	CLEAR + TEMP* + RGB + IR channels active

*When TEMPEN set to 1.

Ambient Configuration Register (0x02)

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
Ambient Configuration	TRIM	COMPEN	TEMPEN	A	MBTIM[2:	D]	AMBP	GA[1:0]	0x02	0x00	R/W

Writing to the Ambient Configuration register aborts any ambient data conversion (registers 0x04 to 0x0F) if already in progress, applies the new settings immediately, and initiates a new conversion.

RGB Color, Infrared, and Temperature Sensors

The 2 AMBPGA[1:0] bits set the gain of the clear/red/green/blue/IR channel measurements according to Table 8.

Table 8. AMBPGA[1:0]

In AMBTIM[2:0] = 000 Mode (100ms integration time)

	CLI	EAR	R	ED	GREEN		
AMBPGA[1:0]	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	
00	2	32.768	2	32.768	2	32.768	
01	8	131.072	8	131.072	8	131.072	
10	32	524.288	32	524.288	32	524.288	
11	512	8388.61	512	8388.61	512	8388.61	

	BL	BLUE IR			
AMBPGA[1:0]	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	
00	4	65.536	2	32.768	
01	16	262.144	8	131.072	
10	64	1048.573	32	524.288	
11	1024	16777.2	512	8388.61	

In AMBTIM[2:0] = 100 Mode (400ms integration time)

	CLI	EAR	R	ED	GREEN		
AMBPGA[1:0]	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	
00	0.5	8.192	0.5	8.192	0.5	8.192	
01	2	32.768	2	32.768	2	32.768	
10	8	131.072	8	131.072	8	131.072	
11	128	2097.153	128	2097.153	128	2097.153	

	BL	UE	IR		
AMBPGA[1:0]	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	nW/cm ² per LSB*	FULL SCALE (µW/cm ²)	
00	1	16.384	0.5	8.192	
01	4	65.536	2	32.768	
10	16	262.1433	8	131.072	
11	256	4194.3	128	2097.153	

RGB Color, Infrared, and Temperature Sensors

The 3 AMBTIM[2:0] bits set the integration time for the red/green/blue/IR/temp channel ADC conversion, as shown in Table 9.

Table 9. AMBTIM[2:0]

AMBTIM[2:0]	INTEGRATION TIME (ms)	FULL-SCALE ADC (COUNTS)	BIT RESOLUTION	RELATIVE LSB SIZE FOR FIXED AMBPGA[1:0]
000	100	16,384	14	1x
001	25	4,096	12	4x
010	6.25	1,024	10	16x
011	1.5625	256	8	64x
100	400	16,384	14	1/4x
101	Reserved	Not applicable	Not applicable	Not applicable
110	Reserved	Not applicable	Not applicable	Not applicable
111	Reserved	Not applicable	Not applicable	Not applicable

TEMPEN

Table 10. TEMPEN

BIT6	OPERATION
0	Disables temperature sensor.
1	Enables temperature sensor.

The integration time of temperature sensor is controlled by the ambient mode settings. The temperature sensor is enabled only if the clear channel is on.

COMPEN

Table 11. COMPEN

BIT5	OPERATION						
0	Disables IR compensation.						
1	Enables IR compensation. Only for MODE[1:0] = 00 Mode.						

The integration time of compensation channel is controlled by the AMB mode settings. The compensation is enabled only when the clear channel is on. When COMPEN = 1, the CLEAR data is automatically compensated for stray IR leakeds and temperature variations. When COMPEN = 0, the IR compensation is disabled, but the output of the IR compensation data exits.

Table 12. TRIM Adjust Enable (TRIM)

BIT7	OPERATION
0	Use factory-programmed gains for all the channels. Ignore any bytes written to TRIM_GAIN_GREEN[6:0], TRIM_GAIN_RED[6:0], TRIM_GAIN_BLUE[6:0], TRIM_GAIN_CLEAR[6:0], and TRIM_GAIN_IR[6:0] registers.
1	Use bytes written to TRIM_GAIN_GREEN[6:0], TRIM_GAIN_RED[6:0], TRIM_GAIN_BLUE[6:0], TRIM_GAIN_CLEAR[6:0], and TRIM_GAIN_IR[6:0] registers to set the gain for each channel.

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REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
	AMBIENT READING										
Ambient CLEAR High Byte	AMB_CLEAR[13:8]								0x04	0x00	R
Ambient CLEAR Low Byte		AMB_CLEAR[7:0]							0x05	0x00	R
Ambient RED High Byte					AMB_R	ED[13:8]			0x06	0x00	R
Ambient RED Low Byte		AMB_RED[7:0]							0x07	0x00	R
Ambient GREEN High Byte		AMB_GREEN[13:8]						0x08	0x00	R	
Ambient GREEN Low Byte	AMB_GREEN[7:0]						0x09	0x00	R		
Ambient BLUE High Byte		AMB_BLUE[13:8]						0x0A	0x00	R	
Ambient BLUE Low Byte	AMB_BLUE[7:0]								0x0B	0x00	R
Ambient INFRARED High Byte	AMB_IR[13:8]						0x0C	0x00	R		
Ambient INFRARED Low Byte	AMB_IR[7:0]						0x0D	0x00	R		
Ambient IR COMP High Byte				AMB_IRCOMP[13:8]						0x00	R
Ambient IR COMP Low Byte				AMB_IR	COMP[7:0]]			0x0F	0x00	R

AMBIENT Data Register (0x04-0x0F)

AMB_CLEAR[13:0], AMB_RED[13:0], AMB_GREEN[13:0], AMB_BLUE[13:0], AMB_IR[13:0], and AMB_IRCOMP[13:0] hold the 14-bit ADC data of the clear/red/green/blue/IR/COMP channels. AMB_IRCOMP[13:0] can be used to enhance overtemperature performance of the devices. The resolution and bit length of the result is controlled by the value of the AMBTIM[2:0] and AMBPGA[1:0] bits. The result is always right justified in the registers, and the unused high bits are set to zero.

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REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BITO	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
TEMP High Byte					TEMP	[13.8]	0x12	0X00	R		
TEMP Low Byte				TEM		0x13	0X00	R			

Temperature Data Register (0x12-0x13)

Ambient Interrupt Threshold Registers (0x14-0x17)

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BITO	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
AMB Upper Threshold— High Byte				UPTHR[13:8]						0xFF	R/W
AMB Upper Threshold— Low Byte		UPTHR[7:0]							0x15	0xFF	R/W
AMB Lower Threshold— High Byte			LOTHR[13:8]						0x16	0x00	R/W
AMB Lower Threshold— Low Byte		LOTHR[7:0]							0x17	0x00	R/W

The ambient upper threshold and lower threshold (UPTHR[13:0] and LOTHR[13:0]) set the window limits that are used to trigger an ambient interrupt, AMBINTS. It is important to set these values according to the selected bit resolution/integration time chosen for the ambient measurement based on the AMBTIM[2:0] and AMBPGA[1:0] settings. The upper 2 bits are always ignored. If the AMBINTE bit is set, and the selected ambient channel data is outside the upper or lower thresholds for a period greater than that defined by the AMBPST persist time, the AMBINTS bit in the Status register is set and the INT pin is pulled low.

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Ambient Threshold Persist Timer Register (0x18)

REGISTER	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	REGISTER ADDRESS	POWER- ON RESET STATE	R/W
Threshold Persist Timer							AMBPST[1:0]		0x18	0x00	R/W

AMBPST[1:0] sets one of four persist values in <u>Table 13</u> that control a time delay before the interrupt logic reacts to a detected event. This feature is added in order to reduce false or nuisance interrupts.

Table 13. AMBPST[1:0]

AMBPST[1:0]	NO. OF CONSECUTIVE MEASUREMENTS REQUIRED TO TRIGGER AN INTERRUPT
00	1
01	4
10	8
11	16

When AMBPST[1:0] is set to 00, and the AMBINTE bit is set to 1, the first time an AMB interrupt event is detected, the AMBINTS interrupt bit is set and the INT pin goes low. If AMBPST[1:0] is set to 01, then four consecutive interrupt events must be detected on four consecutive measurement cycles. Similarly, if AMBPST[1:0] is set to 10 or 11, then 8 or 16 consecutive interrupt events must be detected. If there is an intervening measurement cycle where no interrupt event is detected, then the count is reset to zero.

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POWER-REGISTER ON REGISTER BIT7 BIT6 BIT5 BIT4 BIT3 BIT2 BIT1 **BITO** R/W ADDRESS RESET STATE Digital Gain Trim TRIM_GAIN_CLEAR[6:0] 0x1D 0xXX R/W of CLEAR Channel Digital Gain Trim of RED TRIM_GAIN_RED[6:0] 0x1E 0xXX R/W Channel Digital Gain Trim R/W TRIM_GAIN_GREEN[6:0] 0x1F 0xXX of GREEN Channel Digital Gain Trim of BLUE TRIM_GAIN_BLUE[6:0] 0x20 0xXX R/W Channel **Digital Gain** Trim of TRIM_GAIN_IR[6:0] 0x21 0xXX R/W **INFRARED** Channel

Gain Trim Registers (0x1D-0x21)

TRIM_GAIN_CLEAR is used to trim the gain of the clear channel. TRIM_GAIN_RED is used to trim the gain of the red channel, TRIM_GAIN_GREEN is used to trim the gain of the green channel, TRIM_GAIN_BLUE is used to trim the gain of the blue channel, and TRIM_GAIN_IR is used to trim the gain of the IR channel.

These registers are loaded with the factory-trimmed gains on power-up. When the TRIM bit in register 0x02 is set to 1, these registers can be overwritten with user-chosen gains. When the TRIM bit is set back to 0, these registers are automatically reloaded with factory-trimmed values.

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Applications Information

Ambient Sensing Applications

Typical applications involve placing the devices behind a glass with a small semitransparent window above it. Use the photodiode sensitive area as shown in Figure 2 to properly position the window above the part.

It is possible to map the RGB color values to an XY coordinate system for ambient color temperature measurement. This information can be used to enhance quality of image display by allowing the instrument to compensate for the human eye's chromatic adaptation—a form of improved autowhite balance. It can also be used to improve the color gamut of RGB LED backlit displays by allowing precise white point adjustment of LED sources. The part comes equipped with internal gain trim registers for the CLEAR, RGB, and IR AMB photodiodes. By suitably choosing the gains for these channels accurate ambient-light readings can be generated in all lighting conditions irrespective of type of glass the part is used under. This is especially useful for color glass applications where, for cosmetic reasons, the part is placed behind a color film to hide its presence and to blend with the product cosmetic look. This film has the peculiar property of attenuating most ambient light but passing through infrared radiation.

Interrupt Operation

Ambient interrupt is enabled by setting bit 0 of register 0x01 to 1. See <u>Table 5</u>. The interrupt pin, \overline{INT} , is an open-drain output and pulls low when an interrupt con-

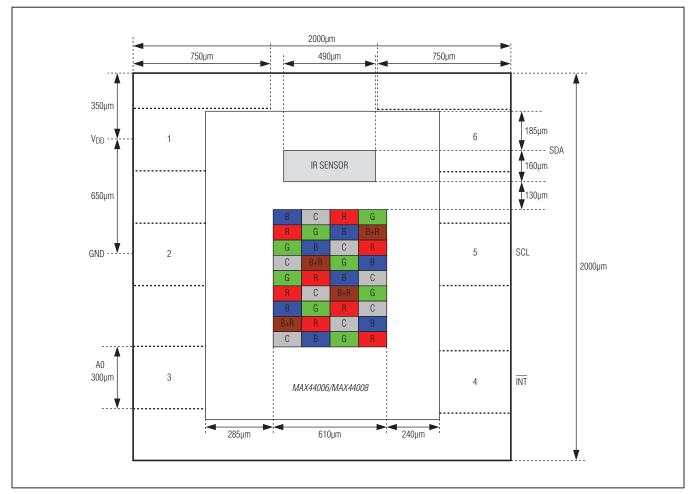


Figure 2. Photodiode Location

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dition occurs (e.g., when ambient lux readings exceed threshold limits for a period greater than that set by the Persist Timer register). The interrupt status bit is cleared automatically if register 0x00 is read or if the interrupts are disabled.

A PWRON interrupt bit is set to alert the master of a chip-reset operation in case of a power-supply glitch, as can happen in instruments during vibration or power fluctuations.

It is recommended to utilize the INT pin on the devices to alert the master to read measurements from the devices. This eliminates the need for the microcontroller (I²C master) to continually poll the devices for information. Due to the use of pullup resistors on the I²C bus, minimizing I²C bus activity can reduce power consumption substantially. In addition, this frees up the microcontroller resources to service other background processes to improve the devices' performance. The wide variety of smarts available on the chip, such as the ability to set the threshold levels and to count persist timer limits, allow the part to operate in an autonomous mode most of the time.

Typical Operating Sequence

The typical operating sequence for the master to communicate to the devices is shown below:

1) Setup:

- a) Read the Interrupt Status register (0x00) to confirm only the PWRON bit is set (usually at power-up only). This also clears the hardware interrupt.
- b) Set Threshold and Persist Timer registers for ambient measurements.
- c) Write 0x00 to Ambient Configuration register (register 0x02) to set the AMB sensor in the most sensitive gain setting, and the AMB ADCs in 14-bit modes of operation.

- d) Write 0x21 to the Main Configuration register (register 0x01) to set the part in CLEAR + TEMP + RGB
 + IR mode and to enable AMB interrupt.
- e) (Optional: Set new CLEAR, RGB, and infrared channel gains if necessary and set TRIM bit in register 0x02 to 1).
- 2) Wait for interrupt.
- 3) On interrupt:
 - a) Read the Interrupt Status register (0x00) to confirm the IC to be the source of interrupt. This should clear the hardware interrupt on the part, if set.
 - b) If an AMB interrupt has occurred, read AMB registers (register 0x04–0x0D) and take appropriate action (e.g., sets new backlight strength/change display gamma). Set new AMB thresholds, if necessary.
 - c) Return to Step 2.

I²C Serial Interface

The devices feature an I²C /SMBus[™]-compatible, 2-wire serial interface consisting of a serial data line (SDA) and a serial clock line (SCL). SDA and SCL facilitate communication between the devices and the master at clock rates up to 400kHz. Figure 3 shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. A master device writes data to the devices by transmitting the proper slave address followed by the register address and then the data word. Each transmit sequence is framed by a START (S) or Repeated START (Sr) condition and a STOP (P) condition. Each word transmitted to the devices is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the IC transmits the proper slave address followed by a series of nine SCL

A0	SLAVE ADDRESS FOR WRITING	SLAVE ADDRESS FOR READING				
MAX44006						
GND	1000 1010	1000 1011				
V _{DD}	1000 1000	1000 1001				
MAX44008						
GND	1000 0010	1000 0011				
V _{DD}	1000 0000	1000 0001				

Table 14. Slave Address

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pulses. The devices transmit data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START or Repeated START condition, a not acknowledge (NACK), and a STOP condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than 500 Ω , is required on the SDA bus. SCL operates as only an input. A pullup resistor, typically greater than 500 Ω , is required on SCL if there are multiple masters on the bus, or if the master in a single-master system has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. Series resistors protect the digital inputs of the devices from high-voltage spikes on the bus lines and minimize crosstalk and undershoot of the bus signal.

Bit Transfer One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals. See the <u>START and STOP Conditions</u> section. SDA and SCL idle high when the $\ensuremath{I^2C}$ bus is not busy.

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 4). A START condition from the master signals the beginning of a transmission to the IC. The master terminates transmission, and frees the bus by issuing a STOP condition. The bus remains active if a Repeated START condition is generated instead of a STOP condition.

Early STOP Conditions

The devices recognize a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

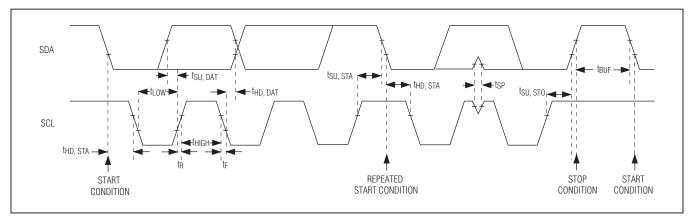


Figure 3. 2-Wire Interface Timing Diagram

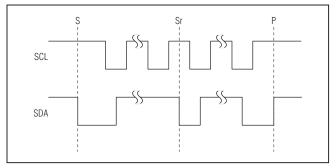


Figure 4. START, STOP, and Repeated START Conditions

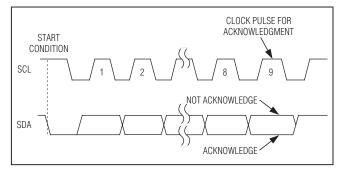


Figure 5. Acknowledge

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Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the devices use to handshake receipt of each byte of data when in write mode (Figure 5). The devices pull down SDA during the entire master-generated ninth clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master can retry communication. The master pulls down SDA during the ninth clock cycle to acknowledge receipt of data when the devices are in read mode. An acknowledge is sent by the master after each read byte to allow data transfer to continue. A not acknowledge (NACK) is sent when the master reads the final byte of data from the device, followed by a STOP condition.

Write Data Format

A write to the devices includes transmission of a START condition, the slave address with the R/\overline{W} bit set to 0, 1 byte of data to configure the internal register address pointer, 1 or more bytes of data, and a STOP condition.

Figure 6 illustrates the proper frame format for writing 1 byte of data to the devices. Figure 7 illustrates the frame format for writing n-bytes of data to the devices.

The slave address with the R/W bit set to 0 indicates that the master intends to write data to the devices. The devices acknowledge receipt of the address byte during the master-generated ninth SCL pulse.

The second byte transmitted from the master configures the devices' internal register address pointer. The pointer tells the devices where to write the next byte of data. An acknowledge pulse is sent by the devices upon receipt of the address pointer data.

The third byte sent to the devices contains the data that is written to the chosen register. An acknowledge pulse from the devices signals receipt of the data byte. The address pointer autoincrements to the next register address after each received data byte. This autoincrement feature allows a master to write to sequential registers within one continuous frame. Figure 8 illustrates how to write to multiple registers with one frame. The master signals the end of transmission by issuing a STOP condition.

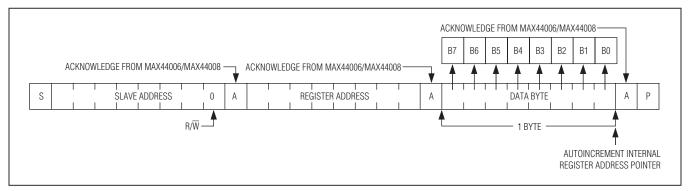


Figure 6. Writing 1 Byte of Data to the MAX44006/MAX44008

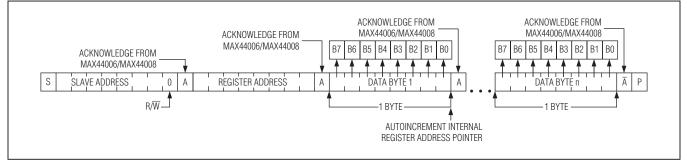
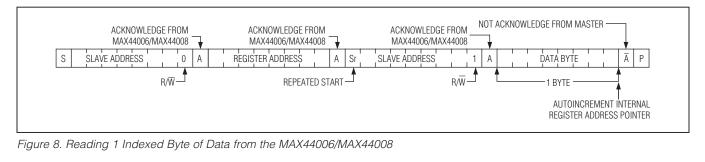


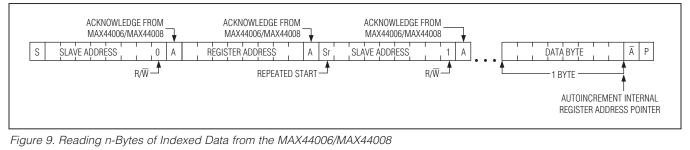
Figure 7. Writing n-Bytes of Data to the MAX44006/MAX44008

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Read Data Format

Send the slave address with the R/W bit set to 1 to initiate a read operation. The devices acknowledge receipt of the slave address by pulling SDA low during the ninth SCL clock pulse. A START command followed by a read command resets the address pointer to register 0x00. The first byte transmitted from the devices comprises the contents of register 0x00. Transmitted data is valid on the rising edge of the master-generated serial clock (SCL). The address pointer autoincrements after each read data byte. This autoincrement feature allows all registers to be read sequentially within one continuous frame. A STOP condition can be issued after any number of read data bytes. If a STOP condition is issued, followed by another read operation, the first data byte to be read is from register 0x00 and subsequent reads autoincrement the address pointer until the next STOP condition. The address pointer can be preset to a specific register before a read command is issued. The master presets the address pointer by first sending the devices' slave address with the R/W bit set to 0, followed by the register address. A Repeated START condition is then sent, followed by the slave address with the R/Wbit set to 1. The devices transmit the contents of the specified register. The address pointer autoincrements after transmitting the first byte. Attempting to read from register addresses higher than 0xFF results in repeated reads of 0xFF. Note that 0xF6 to 0xFF are reserved registers. The master acknowledges receipt of each read byte during the acknowledge clock pulse. The master must acknowledge all correctly received bytes except the last byte. The final byte must be followed by a NACK from the master and then a STOP condition. Figure 8 illustrates the frame format for reading 1 byte from the devices. Figure 9 illustrates the frame format for reading multiple bytes from the devices. Figure 10 illustrates the frame format for reading two registers consecutively without a STOP condition in between reads.





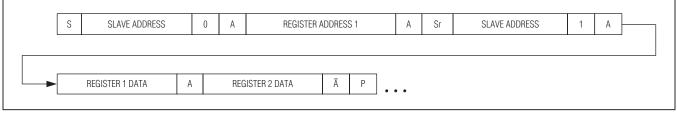
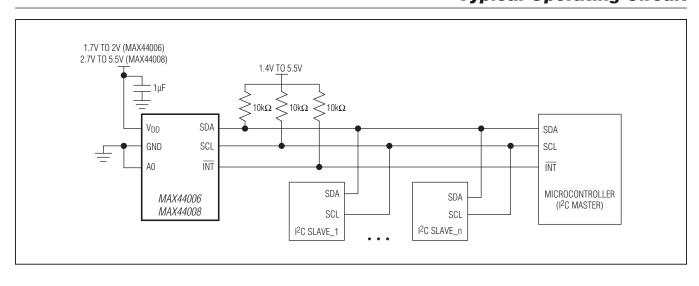


Figure 10. Reading Two Registers Consecutively Without a STOP Condition in Between Reads

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Typical Operating Circuit

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX44006EDT+	-40°C to +85°C	6 OTDFN
MAX44006EDT+T	-40°C to +85°C	6 OTDFN
MAX44008EDT+	-40°C to +85°C	6 OTDFN
MAX44008EDT+T	-40°C to +85°C	6 OTDFN

+Denotes a lead(Pb)-free/RoHS-compliant package. T = Tape and reel.

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE			LAND PATTERN NO.	
6 OTDFN	D622CN+1	<u>21-0606</u>	<u>90-0376</u>	